

# SN5446A, '47A, '48, SN54LS47, 'LS48, 'LS49 SN7446A, '47A, '48, SN74LS47, 'LS48, 'LS49 BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS

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## '46A, '47A, 'LS47 feature

- Open-Collector Outputs Drive Indicators Directly
- Lamp-Test Provision
- Leading/Trailing Zero Suppression

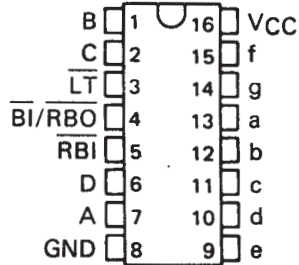
## '48, 'LS48 feature

- Internal Pull-Ups Eliminate Need for External Resistors
- Lamp-Test Provision
- Leading/Trailing Zero Suppression

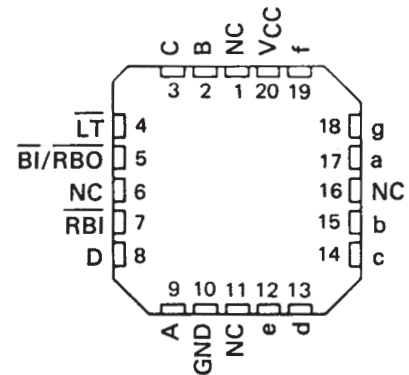
## 'LS49 feature

- Open-Collector Outputs
- Blanking Input

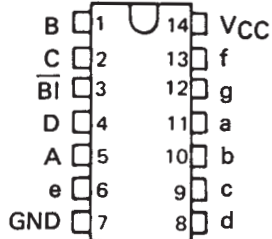
SN5446A, SN5447A, SN54LS47, SN5448,  
 SN54LS48 . . . J PACKAGE  
 SN7446A, SN7447A,  
 SN7448 . . . N PACKAGE  
 SN74LS47, SN74LS48 . . . D OR N PACKAGE  
 (TOP VIEW)



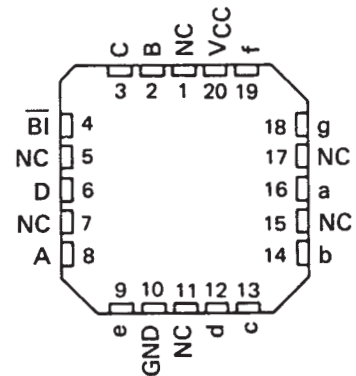
SN54LS47, SN54LS48 . . . FK PACKAGE  
 (TOP VIEW)



SN54LS49 . . . J OR W PACKAGE  
 SN74LS49 . . . D OR N PACKAGE  
 (TOP VIEW)



SN54LS49 . . . FK PACKAGE  
 (TOP VIEW)



NC — No internal connection

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
 INSTRUMENTS**

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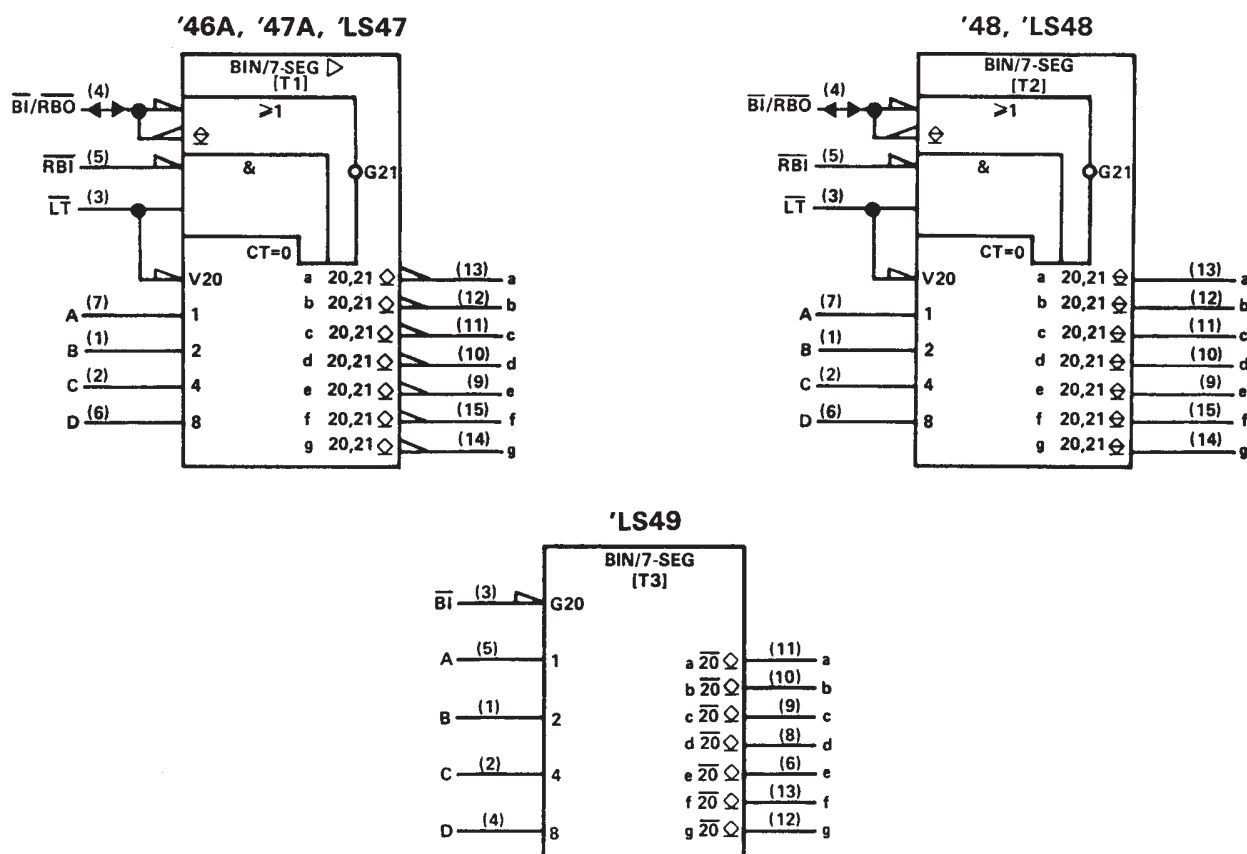
# SN5446A, '47A, '48, SN54LS47, 'LS48, 'LS49 SN7446A, '47A, '48, SN74LS47, 'LS48, 'LS49 BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS

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- All Circuit Types Feature Lamp Intensity Modulation Capability

TYPE	DRIVER OUTPUTS				TYPICAL POWER DISSIPATION	PACKAGES
	ACTIVE LEVEL	OUTPUT CONFIGURATION	SINK CURRENT	MAX VOLTAGE		
SN5446A	low	open-collector	40 mA	30 V	320 mW	J, W
SN5447A	low	open-collector	40 mA	15 V	320 mW	J, W
SN5448	high	2-k $\Omega$ pull-up	6.4 mA	5.5 V	265 mW	J, W
SN54LS47	low	open-collector	12 mA	15 V	35 mW	J, W
SN54LS48	high	2-k $\Omega$ pull-up	2 mA	5.5 V	125 mW	J, W
SN54LS49	high	open-collector	4 mA	5.5 V	40 mW	J, W
SN7446A	low	open-collector	40 mA	30 V	320 mW	J, N
SN7447A	low	open-collector	40 mA	15 V	320 mW	J, N
SN7448	high	2-k $\Omega$ pull-up	6.4 mA	5.5 V	265 mW	J, N
SN74LS47	low	open-collector	24 mA	15 V	35 mW	J, N
SN74LS48	high	2-k $\Omega$ pull-up	6 mA	5.5 V	125 mW	J, N
SN74LS49	high	open-collector	8 mA	5.5 V	40 mW	J, N

logic symbols†



†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.  
Pin numbers shown are for D, J, N, and W packages.



SN5446A, '47A, '48, SN54LS47, 'LS48, 'LS49  
SN7446A, '47A, '48, SN74LS47, 'LS48, 'LS49  
BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS

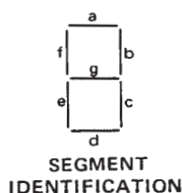
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## description

The '46A, '47A, and 'LS47 feature active-low outputs designed for driving common-anode LEDs or incandescent indicators directly. The '48, 'LS48, and 'LS49 feature active-high outputs for driving lamp buffers or common-cathode LEDs. All of the circuits except 'LS49 have full ripple-blanking input/output controls and a lamp test input. The 'LS49 circuit incorporates a direct blanking input. Segment identification and resultant displays are shown below. Display patterns for BCD input counts above 9 are unique symbols to authenticate input conditions.

The '46A, '47A, '48, 'LS47, and 'LS48 circuits incorporate automatic leading and/or trailing-edge zero-blanking control ( $\overline{\text{RBI}}$  and  $\overline{\text{RBO}}$ ). Lamp test ( $\overline{\text{LT}}$ ) of these types may be performed at any time when the  $\overline{\text{BI/RBO}}$  node is at a high level. All types (including the '49 and 'LS49) contain an overriding blanking input ( $\overline{\text{BI}}$ ), which can be used to control the lamp intensity by pulsing or to inhibit the outputs. Inputs and outputs are entirely compatible for use with TTL logic outputs.

The SN54246/SN74246 and '247 and the SN54LS247/SN74LS247 and 'LS248 compose the  and the  with tails and were designed to offer the designer a choice between two indicator fonts.



NUMERICAL DESIGNATIONS AND RESULTANT DISPLAYS

'46A, '47A, 'LS47 FUNCTION TABLE (T1)

DECIMAL OR FUNCTION	INPUTS						$\overline{\text{BI/RBO}}^\dagger$	OUTPUTS							NOTE
	$\overline{\text{LT}}$	$\overline{\text{RBI}}$	D	C	B	A		a	b	c	d	e	f	g	
0	H	H	L	L	L	L	H	ON	ON	ON	ON	ON	ON	OFF	1
1	H	X	L	L	L	H	H	OFF	ON	ON	OFF	OFF	OFF	OFF	
2	H	X	L	L	H	L	H	ON	ON	OFF	ON	ON	OFF	ON	
3	H	X	L	L	H	H	H	ON	ON	ON	ON	OFF	OFF	ON	
4	H	X	L	H	L	L	H	OFF	ON	ON	OFF	OFF	ON	ON	
5	H	X	L	H	L	H	H	ON	OFF	ON	ON	OFF	ON	ON	
6	H	X	L	H	H	L	H	OFF	OFF	ON	ON	ON	ON	ON	
7	H	X	L	H	H	H	H	ON	ON	ON	OFF	OFF	OFF	OFF	
8	H	X	H	L	L	L	H	ON	ON	ON	ON	ON	ON	ON	
9	H	X	H	L	L	H	H	ON	ON	ON	OFF	OFF	ON	ON	
10	H	X	H	L	H	L	H	OFF	OFF	OFF	ON	ON	OFF	ON	
11	H	X	H	L	H	H	H	OFF	OFF	ON	ON	OFF	OFF	ON	
12	H	X	H	H	L	L	H	OFF	ON	OFF	OFF	OFF	ON	ON	
13	H	X	H	H	L	H	H	ON	OFF	OFF	ON	OFF	ON	ON	
14	H	X	H	H	H	L	H	OFF	OFF	OFF	ON	ON	ON	ON	
15	H	X	H	H	H	H	H	OFF	OFF	OFF	OFF	OFF	OFF	OFF	
BI	X	X	X	X	X	X	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	2
RBI	H	L	L	L	L	L	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	3
LT	L	X	X	X	X	X	H	ON	ON	ON	ON	ON	ON	ON	4

H = high level, L = low level, X = irrelevant

NOTES: 1. The blanking input ( $\overline{\text{BI}}$ ) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple-blanking input ( $\overline{\text{RBI}}$ ) must be open or high if blanking of a decimal zero is not desired.

2. When a low logic level is applied directly to the blanking input ( $\overline{\text{BI}}$ ), all segment outputs are off regardless of the level of any other input.

3. When ripple-blanking input ( $\overline{\text{RBI}}$ ) and inputs A, B, C, and D are at a low level with the lamp test input high, all segment outputs go off and the ripple-blanking output ( $\overline{\text{RBO}}$ ) goes to a low level (response condition).

4. When the blanking input/ripple blanking output ( $\overline{\text{BI/RBO}}$ ) is open or held high and a low is applied to the lamp-test input, all segment outputs are on.

$^\dagger \overline{\text{BI/RBO}}$  is wire AND logic serving as blanking input ( $\overline{\text{BI}}$ ) and/or ripple-blanking output ( $\overline{\text{RBO}}$ ).

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'48, 'LS48  
 FUNCTION TABLE (T2)

DECIMAL OR FUNCTION	INPUTS						$\overline{\text{BI}}/\overline{\text{RBO}}^\dagger$	OUTPUTS							NOTE
	LT	RBI	D	C	B	A		a	b	c	d	e	f	g	
0	H	H	L	L	L	L	H	H	H	H	H	H	H	L	1
1	H	X	L	L	L	H	H	L	H	H	L	L	L	L	
2	H	X	L	L	H	L	H	H	H	L	H	H	L	H	
3	H	X	L	L	H	H	H	H	H	H	L	L	L	H	
4	H	X	L	H	L	L	H	L	H	H	L	L	H	H	
5	H	X	L	H	L	H	H	H	L	H	H	L	H	H	
6	H	X	L	H	H	L	H	L	L	H	H	H	H	H	
7	H	X	L	H	H	H	H	H	H	H	L	L	L	L	
8	H	X	H	L	L	L	H	H	H	H	H	H	H	H	
9	H	X	H	L	L	H	H	H	H	L	L	L	H	H	
10	H	X	H	L	H	L	H	L	L	L	H	H	L	H	
11	H	X	H	L	H	H	H	L	L	H	H	L	L	H	
12	H	X	H	H	L	L	H	L	H	L	L	L	H	H	
13	H	X	H	H	L	H	H	H	L	L	L	H	L	H	
14	H	X	H	H	H	L	H	L	L	L	H	H	H	H	
15	H	X	H	H	H	H	H	L	L	L	L	L	L	L	
BI	X	X	X	X	X	X	L	L	L	L	L	L	L	L	2
RBI	L	L	L	L	L	L	L	L	L	L	L	L	L	L	3
LT	L	X	X	X	X	X	H	H	H	H	H	H	H	H	4

H = high level, L = low level, X = irrelevant

- NOTES: 1. The blanking input ( $\overline{\text{BI}}$ ) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple-blanking input ( $\overline{\text{RBI}}$ ) must be open or high, if blanking of a decimal zero is not desired.
2. When a low logic level is applied directly to the blanking input ( $\overline{\text{BI}}$ ), all segment outputs are low regardless of the level of any other input.
3. When ripple-blanking input ( $\overline{\text{RBI}}$ ) and inputs A, B, C, and D are at a low level with the lamp-test input high, all segment outputs go low and the ripple-blanking output ( $\overline{\text{RBO}}$ ) goes to a low level (response condition).
4. When the blanking input/ripple-blanking output ( $\overline{\text{BI}}/\overline{\text{RBO}}$ ) is open or held high and a low is applied to the lamp-test input, all segment outputs are high.

$^\dagger \overline{\text{BI}}/\overline{\text{RBO}}$  is wire-AND logic serving as blanking input ( $\overline{\text{BI}}$ ) and/or ripple-blanking output ( $\overline{\text{RBO}}$ ).

'LS49  
 FUNCTION TABLE (T3)

DECIMAL OR FUNCTION	INPUTS						OUTPUTS							NOTE
	D	C	B	A	$\overline{\text{BI}}$		a	b	c	d	e	f	g	
0	L	L	L	L	H		H	H	H	H	H	H	L	1
1	L	L	L	H	H		L	H	H	L	L	L	L	
2	L	L	H	L	H		H	H	L	H	H	L	H	
3	L	L	H	H	H		H	H	H	H	L	L	H	
4	L	H	L	L	H		L	H	H	L	L	H	H	
5	L	H	L	H	H		H	L	H	H	L	H	H	
6	L	H	H	L	H		L	L	H	H	H	H	H	
7	L	H	H	H	H		H	H	H	L	L	L	L	
8	H	L	L	L	H		H	H	H	H	H	H	H	
9	H	L	L	H	H		H	H	H	L	L	H	H	
10	H	L	H	L	H		L	L	L	H	H	L	H	
11	H	L	H	H	H		L	L	H	H	L	L	H	
12	H	H	L	L	H		L	H	L	L	L	H	H	
13	H	H	L	H	H		H	L	L	L	H	L	H	
14	H	H	H	L	H		L	L	L	H	H	H	H	
15	H	H	H	H	H		L	L	L	L	L	L	L	
BI	X	X	X	X	L		L	L	L	L	L	L	L	2

H = high level, L = low level, X = irrelevant

- NOTES: 1. The blanking input ( $\overline{\text{BI}}$ ) must be open or held at a high logic level when output functions 0 through 15 are desired.
2. When a low logic level is applied directly to the blanking input ( $\overline{\text{BI}}$ ), all segment outputs are low regardless of the level of any other input.

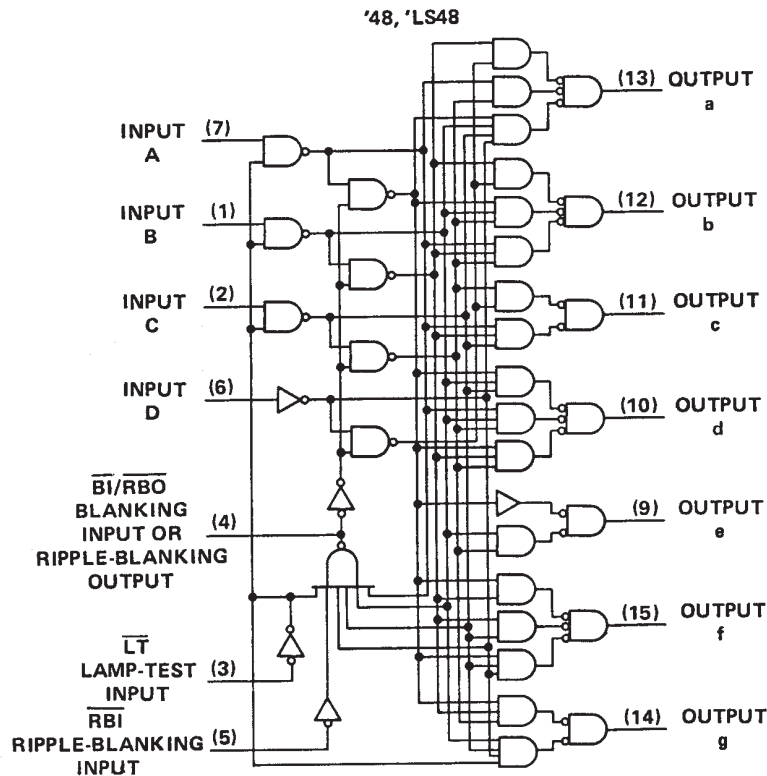
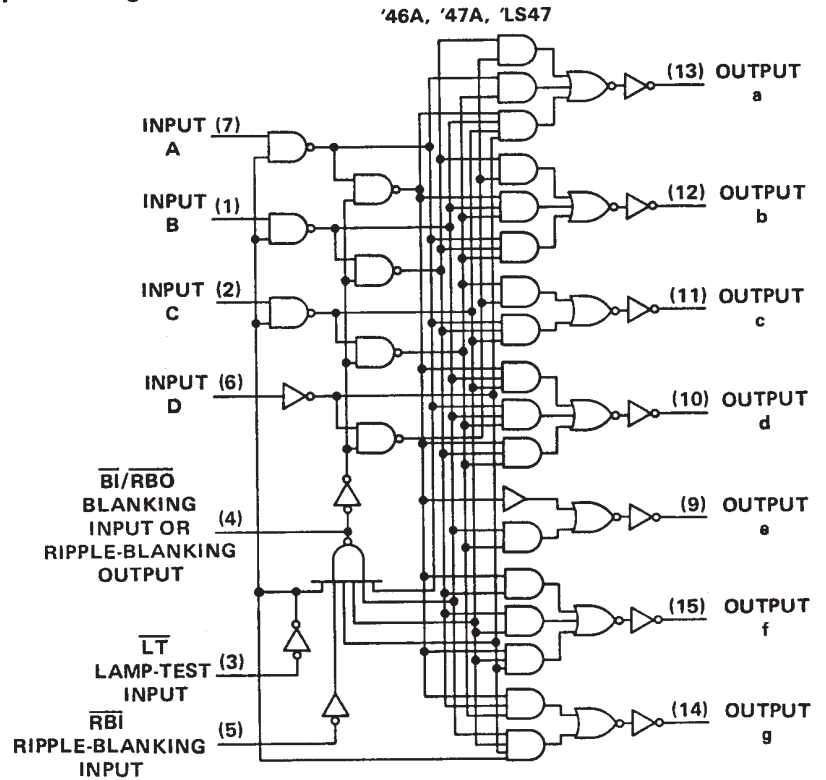


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logic diagrams (positive logic)



Pin numbers shown are for D, J, N, and W packages.

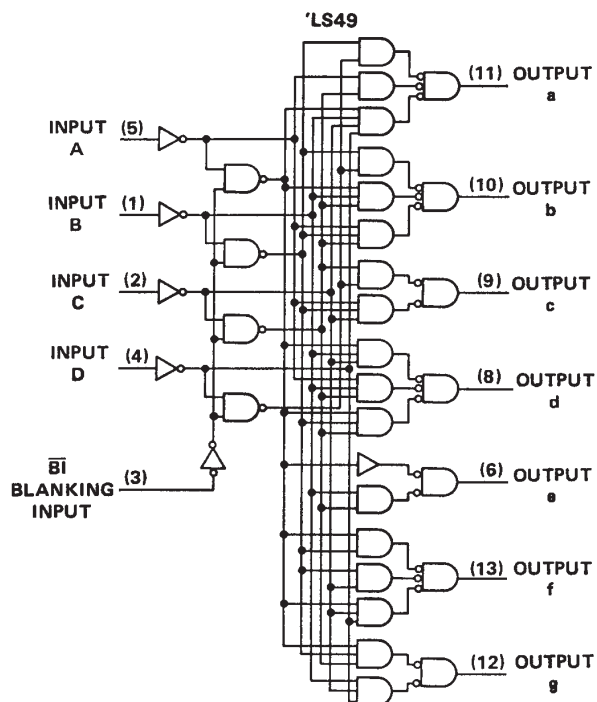


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SN5446A, '47A, '48, SN54LS47, 'LS48, 'LS49  
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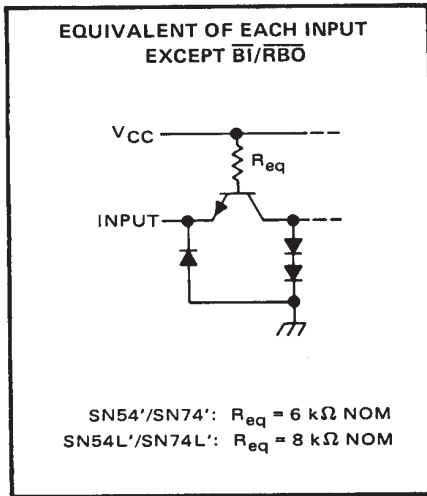
logic diagrams (continued)



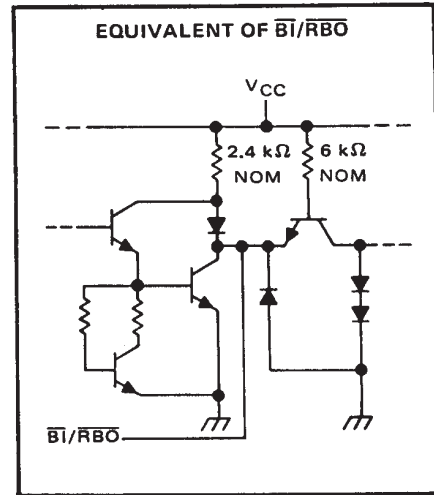
Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs

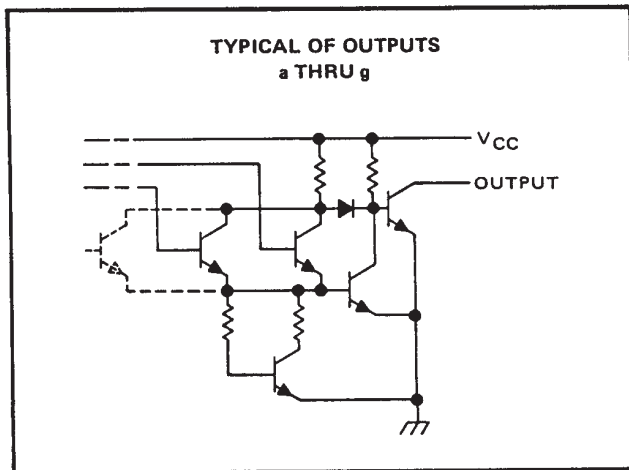
'46A, '47A, '48



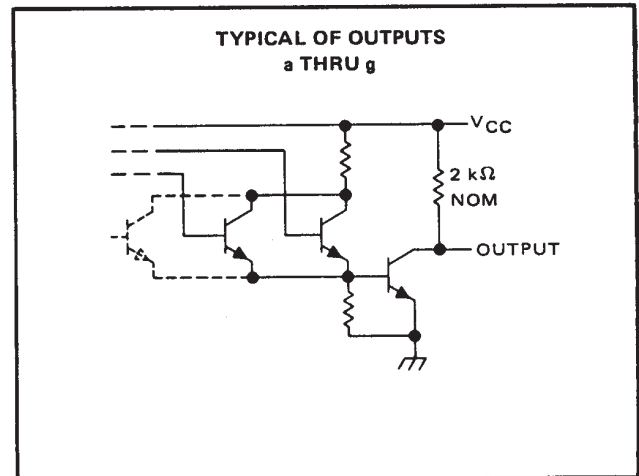
'46A, '47A, '48



'46A, '47A



'48



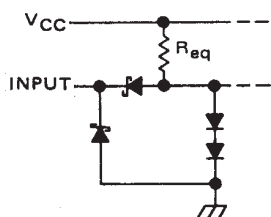
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 SN7446A, '47A, '48, SN74LS47, 'LS48, 'LS49  
 BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS

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schematics of inputs and outputs

'LS47, 'LS48, 'LS49

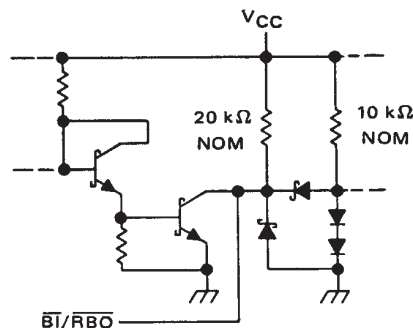
EQUIVALENT OF EACH INPUT  
 EXCEPT  $\overline{\text{BI}}/\overline{\text{RBO}}$



$\overline{\text{LT}}$  and  $\overline{\text{RB}}\overline{\text{I}}$  ('LS47, 'LS48):  $R_{eq} = 20 \text{ k}\Omega \text{ NOM}$   
 $\overline{\text{BI}}$  ('LS49):  $R_{eq} = 20 \text{ k}\Omega \text{ NOM}$   
 A, B, C, and D:  $R_{eq} = 25 \text{ k}\Omega \text{ NOM}$

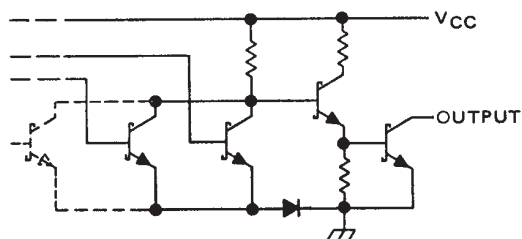
'LS47, 'LS48, 'LS49

EQUIVALENT OF  $\overline{\text{BI}}/\overline{\text{RBO}}$



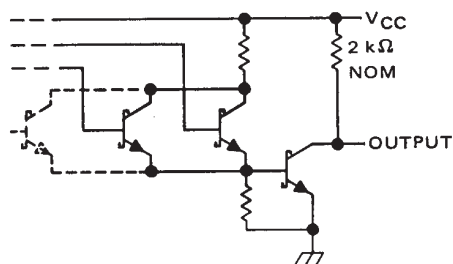
'LS47

TYPICAL OF OUTPUTS  
 a THRU g



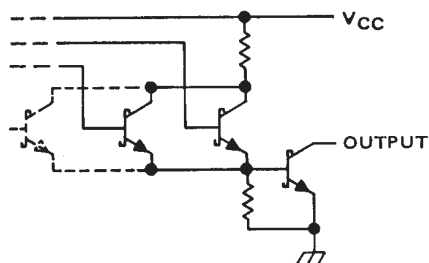
'LS48

TYPICAL OF OUTPUTS  
 a THRU g



'LS49

TYPICAL OF OUTPUTS  
 a THRU g





SN5446A, '47A, '48, SN54LS47, 'LS48, 'LS49  
SN7446A, '47A, '48, SN74LS47, 'LS48, 'LS49  
BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, $V_{CC}$ (see Note 1)	7 V
Input voltage	5.5 V
Current forced into any output in the off state	1 mA
Operating free-air temperature range: SN5446A, SN5447A	–55°C to 125°C
SN7446A, SN7447A	0°C to 70°C
Storage temperature range	–65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN5446A			SN5447A			SN7446A			SN7447A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, $V_{CC}$		4.5	5	5.5	4.5	5	5.5	4.75	5	5.25	4.75	5	5.25	V
Off-state output voltage, $V_{O(off)}$	a thru g			30			15			30			15	V
On-state output current, $I_{O(on)}$	a thru g			40			40			40			40	mA
High-level output current, $I_{OH}$	$\overline{BI}/\overline{RBO}$			–200			–200			–200			–200	μA
Low-level output current, $I_{OL}$	$\overline{BI}/\overline{RBO}$			8			8			8			8	mA
Operating free-air temperature, $T_A$		–55		125	–55		125	0		70	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		MIN	TYP‡	MAX	UNIT
$V_{IH}$	High-level input voltage			2			V
$V_{IL}$	Low-level input voltage					0.8	V
$V_{IK}$	Input clamp voltage	$V_{CC} = \text{MIN}, I_I = -12 \text{ mA}$				–1.5	V
$V_{OH}$	High-level output voltage	$\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V},$ $V_{IL} = 0.8 \text{ V}, I_{OH} = -200 \text{ μA}$		2.4	3.7		V
$V_{OL}$	Low-level output voltage	$\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V},$ $V_{IL} = 0.8 \text{ V}, I_{OL} = 8 \text{ mA}$			0.27	0.4	V
$I_{O(off)}$	Off-state output current	a thru g $V_{CC} = \text{MAX}, V_{IH} = 2 \text{ V},$ $V_{IL} = 0.8 \text{ V}, V_{O(off)} = \text{MAX}$				250	μA
$V_{O(on)}$	On-state output voltage	a thru g $V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V},$ $V_{IL} = 0.8 \text{ V}, I_{O(on)} = 40 \text{ mA}$			0.3	0.4	V
$I_I$	Input current at maximum input voltage	Any input except $\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MAX}, V_I = 5.5 \text{ V}$				1	mA
$I_{IH}$	High-level input current	Any input except $\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MAX}, V_I = 2.4 \text{ V}$				40	μA
$I_{IL}$	Low-level input current	Any input except $\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MAX}, V_I = 0.4 \text{ V}$				–1.6	mA
		$\overline{BI}/\overline{RBO}$				–4	
$I_{OS}$	Short-circuit output current	$\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MAX}$				–4	mA
$I_{CC}$	Supply current	$V_{CC} = \text{MAX},$	SN54'			64	mA
		See Note 2	SN74'			64	

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at  $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$ .

NOTE 2:  $I_{CC}$  is measured with all outputs open and all inputs at 4.5 V.

switching characteristics,  $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
$t_{off}$	Turn-off time from A input	$C_L = 15 \text{ pF}, R_L = 120 \Omega,$ See Note 3				100	ns
$t_{on}$	Turn-on time from A input					100	
$t_{off}$	Turn-off time from $\overline{RBI}$ input					100	ns
$t_{on}$	Turn-on time from $\overline{RBI}$ input					100	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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 SN7446A, '47A, '48, SN74LS47, 'LS48, 'LS49  
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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, $V_{CC}$ (see Note 1)	7 V
Input voltage	5.5 V
Operating free-air temperature range: SN5448	–55°C to 125°C
SN7448	0°C to 70°C
Storage temperature range	–65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN5448			SN7448			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, $V_{CC}$		4.5	5	5.5	4.75	5	5.25	V
High-level output current, $I_{OH}$	a thru g			–400			–400	$\mu$ A
	$\overline{BI}/\overline{RBO}$			–200			–200	
Low-level output current, $I_{OL}$	a thru g			6.4			6.4	mA
	$\overline{BI}/\overline{RBO}$			8			8	
Operating free-air temperature, $T_A$		–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	MIN	TYP‡	MAX	UNIT
$V_{IH}$	High-level input voltage		2			V
$V_{IL}$	Low-level input voltage				0.8	V
$V_{IK}$	Input clamp voltage	$V_{CC} = \text{MIN}, I_I = -12 \text{ mA}$			–1.5	V
$V_{OH}$	High-level output voltage	a thru g $V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V},$ $V_{IL} = 0.8 \text{ V}, I_{OH} = \text{MAX}$	2.4	4.2		V
			2.4	3.7		
$I_O$	Output current	a thru g $V_{CC} = \text{MIN}, V_O = 0.85 \text{ V},$ Input conditions as for $V_{OH}$	–1.3	–2		mA
$V_{OL}$	Low-level output voltage	$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V},$ $V_{IL} = 0.8 \text{ V}, I_{OL} = \text{MAX}$		0.27	0.4	V
$I_I$	Input current at maximum input voltage	Any input except $\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MAX}, V_I = 5.5 \text{ V}$			1	mA
$I_{IH}$	High-level input current	Any input except $\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MAX}, V_I = 2.4 \text{ V}$			40	$\mu$ A
$I_{IL}$	Low-level input current	Any input except $\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MAX}, V_I = 0.4 \text{ V}$			–1.6	mA
		$\overline{BI}/\overline{RBO}$			–4	
$I_{OS}$	Short-circuit output current	$\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MAX}$			–4	mA
$I_{CC}$	Supply current	$V_{CC} = \text{MAX},$ See Note 2	SN5448	53	76	mA
			SN7448	53	90	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at  $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$ .

NOTE 2:  $I_{CC}$  is measured with all outputs open and all inputs at 4.5 V.

switching characteristics,  $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{PHL}$ Propagation delay time, high-to-low-level output from A input	$C_L = 15 \text{ pF}, R_L = 1 \text{ k}\Omega$ See Note 3			100	ns
$t_{PLH}$ Propagation delay time, low-to-high-level output from A input				100	
$t_{PHL}$ Propagation delay time, high-to-low-level output from $\overline{RBI}$ input				100	ns
$t_{PLH}$ Propagation delay time, low-to-high-level output from $\overline{RBI}$ input				100	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



SN5446A, '47A, '48, SN54LS47, 'LS48, 'LS49  
SN7446A, '47A, '48, SN74LS47, 'LS48, 'LS49  
BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS

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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)**

Supply voltage, $V_{CC}$ (see Note 1)	7 V
Input voltage	7 V
Peak output current ( $t_W \leq 1$ ms, duty cycle $\leq 10\%$ )	200 mA
Current forced into any output in the off state	1 mA
Operating free-air temperature range: SN54LS47	$-55^{\circ}\text{C}$ to $125^{\circ}\text{C}$
SN74LS47	$0^{\circ}\text{C}$ to $70^{\circ}\text{C}$
Storage temperature range	$-65^{\circ}\text{C}$ to $150^{\circ}\text{C}$

NOTE 1: Voltage values are with respect to network ground terminal.

**recommended operating conditions**

		SN54LS47			SN74LS47			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, $V_{CC}$		4.5	5	5.5	4.75	5	5.25	V
Off-state output voltage, $V_{O(\text{off})}$	a thru g			15			15	V
On-state output current, $I_{O(\text{on})}$	a thru g			12			24	mA
High-level output current, $I_{OH}$	$\overline{BI}/\overline{RBO}$			-50			-50	$\mu\text{A}$
Low-level output current, $I_{OL}$	$\overline{BI}/\overline{RBO}$			1.6			3.2	mA
Operating free-air temperature, $T_A$		-55		125	0		70	$^{\circ}\text{C}$

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS†	SN54LS47			SN74LS47			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
$V_{IH}$	High-level input voltage		2			2			V
$V_{IL}$	Low-level input voltage				0.7			0.8	V
$V_{IK}$	Input clamp voltage	$V_{CC} = \text{MIN}, I_I = -18$ mA			-1.5			-1.5	V
$V_{OH}$	High-level output voltage	$\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MIN}, V_{IH} = 2$ V, $V_{IL} = V_{IL \text{ max}}, I_{OH} = -50$ $\mu\text{A}$	2.4	4.2		2.4	4.2		V
$V_{OL}$	Low-level output voltage	$\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MIN}, V_{IH} = 2$ V, $V_{IL} = V_{IL \text{ max}}, I_{OL} = 1.6$ mA $I_{OL} = 3.2$ mA	0.25	0.4		0.25	0.4	0.5	V
$I_{O(\text{off})}$	Off-state output current	a thru g $V_{CC} = \text{MAX}, V_{IH} = 2$ V, $V_{IL} = V_{IL \text{ max}}, V_{O(\text{off})} = 15$ V			250			250	$\mu\text{A}$
$V_{O(\text{on})}$	On-state output voltage	a thru g $V_{CC} = \text{MIN}, V_{IH} = 2$ V, $V_{IL} = V_{IL \text{ max}}, I_{O(\text{on})} = 12$ mA $I_{O(\text{on})} = 24$ mA	0.25	0.4		0.25	0.4	0.5	V
$I_I$	Input current at maximum input voltage	$V_{CC} = \text{MAX}, V_I = 7$ V			0.1			0.1	mA
$I_{IH}$	High-level input current	$V_{CC} = \text{MAX}, V_I = 2.7$ V			20			20	$\mu\text{A}$
$I_{IL}$	Low-level input current	Any input except $\overline{BI}/\overline{RBO}$ $\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MAX}, V_I = 0.4$ V			-0.4			-0.4	mA
					-1.2			-1.2	
$I_{OS}$	Short-circuit output current	$\overline{BI}/\overline{RBO}$ $V_{CC} = \text{MAX}$	-0.3		-2	-0.3		-2	mA
$I_{CC}$	Supply current	$V_{CC} = \text{MAX},$ See Note 2	7		13	7		13	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at  $V_{CC} = 5$  V,  $T_A = 25^{\circ}\text{C}$ .

NOTE 2:  $I_{CC}$  is measured with all outputs open and all inputs at 4.5 V.

**switching characteristics,  $V_{CC} = 5$  V,  $T_A = 25^{\circ}\text{C}$**

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{\text{off}}$	Turn-off time from A input			100	ns
$t_{\text{on}}$	Turn-on time from A input			100	
$t_{\text{off}}$	Turn-off time from $\overline{RBI}$ input, outputs (a-f) only			100	ns
$t_{\text{on}}$	Turn-on time from $\overline{RBI}$ input, outputs (a-f) only			100	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



**SN5446A, '47A, '48, SN54LS47, 'LS48, 'LS49**  
**SN7446A, '47A, '48, SN74LS47, 'LS48, 'LS49**  
**BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS**

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, $V_{CC}$ (see Note 1)	7 V
Input voltage	7 V
Operating free-air temperature range: SN54LS48	–55°C to 125°C
SN74LS48	0°C to 70°C
Storage temperature range	–65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54LS48			SN74LS48			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, $V_{CC}$		4.5	5	5.5	4.75	5	5.25	V
High-level output current, $I_{OH}$	a thru g	-100			-100			$\mu$ A
	$\overline{BI}/\overline{RBO}$	-50			-50			
Low-level output current, $I_{OL}$	a thru g	2			6			mA
	$\overline{BI}/\overline{RBO}$	1.6			3.2			
Operating free-air temperature, $T_A$		-55			0			$^{\circ}$ C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†	SN54LS48		SN74LS48		UNIT	
				MIN	TYP‡ MAX	MIN	TYP‡ MAX		
V <sub>IH</sub>	High-level input voltage			2		2		V	
V <sub>IL</sub>	Low-level input voltage			0.7		0.8		V	
V <sub>IK</sub>	Input clamp voltage		V <sub>CC</sub> = MIN, I <sub>I</sub> = −18 mA		−1.5		−1.5		V
V <sub>OH</sub>	High-level output voltage	a thru g and $\overline{\text{BI}}/\overline{\text{RBO}}$	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = V <sub>IL</sub> max, I <sub>OH</sub> = MAX		2.4	4.2	2.4	4.2	V
I <sub>O</sub>	Output current	a thru g	V <sub>CC</sub> = MIN, V <sub>O</sub> = 0.85 V, Input conditions as for V <sub>OH</sub>		−1.3	−2	−1.3	−2	mA
V <sub>OL</sub>	Low-level output voltage	a thru g	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = V <sub>IL</sub> max	I <sub>OL</sub> = 2 mA	0.25	0.4	0.25	0.4	V
				I <sub>OL</sub> = 6 mA			0.35	0.5	
	$\overline{\text{BI}}/\overline{\text{RBO}}$	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = V <sub>IL</sub> max	I <sub>OL</sub> = 1.6 mA	0.25	0.4	0.25	0.4	V	
			I <sub>OL</sub> = 3.2 mA			0.35	0.5		
I <sub>I</sub>	Input current at maximum input voltage	Any input except $\overline{\text{BI}}/\overline{\text{RBO}}$	V <sub>CC</sub> = MAX, V <sub>I</sub> = 7 V		0.1		0.1		mA
I <sub>IH</sub>	High-level input current	Any input except $\overline{\text{BI}}/\overline{\text{RBO}}$	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V		20		20		μA
I <sub>IL</sub>	Low-level input current	Any input except $\overline{\text{BI}}/\overline{\text{RBO}}$	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.4 V		−0.4		−0.4		mA
		$\overline{\text{BI}}/\overline{\text{RBO}}$			−1.2		−1.2		
I <sub>OS</sub>	Short-circuit output current	$\overline{\text{BI}}/\overline{\text{RBO}}$	V <sub>CC</sub> = MAX		−0.3	−2	−0.3	−2	mA
I <sub>CC</sub>	Supply current		V <sub>CC</sub> = MAX, See Note 2		25	38	25	38	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at  $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$ .

NOTE 2:  $I_{CC}$  is measured with all outputs open and all inputs at 4.5 V.

switching characteristics,  $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{PHL}$ Propagation delay time, high-to-low-level output from A input	$C_L = 15 \text{ pF}, R_L = 4 \text{ k}\Omega,$		100		ns
$t_{PLH}$ Propagation delay time, low-to-high-level output from A input	See Note 3		100		
$t_{PHL}$ Propagation delay time, high-to-low-level output (a-f only) from $\overline{RBI}$ input	$C_L = 15 \text{ pF}, R_L = 6 \text{ k}\Omega,$		100		ns
$t_{PLH}$ Propagation delay time, low-to-high-level output (a-f only) from $\overline{RBI}$ input	See Note 3		100		

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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SN5446A, '47A, '48, SN54LS47, 'LS48, 'LS49  
 SN7446A, '47A, '48, SN74LS47, 'LS48, 'LS49  
 BCD-TO-SEVEN-SEGMENT DECODERS/DRIVERS  
 SDLS111 – MARCH 1974 – REVISED MARCH 1988

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, $V_{CC}$ (see Note 1)	7 V
Input voltage	7 V
Current forced into any output in the off state	1 mA
Operating free-air temperature range: SN54LS49	–55°C to 125°C
SN74LS49	0°C to 70°C
Storage temperature range	–65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	SN54LS49			SN74LS49			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, $V_{CC}$	4.5	5	5.5	4.75	5	5.25	V
High-level output voltage, $V_{OH}$			5.5			5.5	V
Low-level output current, $I_{OL}$			4			8	mA
Operating free-air temperature, $T_A$	–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	SN54LS49			SN74LS49			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V <sub>IH</sub>	High-level input voltage		2			2			V
V <sub>IL</sub>	Low-level input voltage				0.7			0.8	V
V <sub>IK</sub>	Input clamp voltage	V <sub>CC</sub> = MIN, I <sub>I</sub> = −18 mA			−1.5			−1.5	V
I <sub>OH</sub>	High-level output current	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = V <sub>IL</sub> max, V <sub>OH</sub> = 5.5 V			250			250	μA
V <sub>OL</sub>	Low-level output voltage	V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = V <sub>IL</sub> max	I <sub>OL</sub> = 4 mA		0.25	0.4	0.25	0.4	V
		I <sub>OL</sub> = 8 mA				0.35	0.5		
I <sub>I</sub>	Input current at maximum input voltage	V <sub>CC</sub> = MAX, V <sub>I</sub> = 7 V			0.1		0.1		mA
I <sub>IH</sub>	High-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V			20		20		μA
I <sub>IL</sub>	Low-level input current	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.4 V			−0.4		−0.4		mA
I <sub>CC</sub>	Supply current	V <sub>CC</sub> = MAX, See Note 2	8	15		8	15		mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

NOTE 2:  $I_{CC}$  is measured with all outputs open and all inputs at 4.5 V.

switching characteristics,  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{PHL}$ Propagation delay time, high-to-low-level output from A input	$C_L = 15 \text{ pF}$ , $R_L = 4 \text{ k}\Omega$ ,			100	ns
$t_{PLH}$ Propagation delay time, low-to-high-level output from A input	See Note 3			100	
$t_{PHL}$ Propagation delay time, high-to-low-level output (a-f only) from $\overline{RBI}$ input	$C_L = 15 \text{ pF}$ , $R_L = 6 \text{ k}\Omega$ ,			100	ns
$t_{PLH}$ Propagation delay time, low-to-high-level output (a-f only) from $\overline{RBI}$ input	See Note 3			100	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



TEXAS  
INSTRUMENTS

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**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9856401QEA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-9856401QE A SNJ5447AJ	<a href="#">Samples</a>
5962-9856401QFA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-9856401QF A SNJ5447AW	<a href="#">Samples</a>
7604501EA	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7604501EA SNJ54LS47J	<a href="#">Samples</a>
SN5447AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN5447AJ	<a href="#">Samples</a>
SN54LS47J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS47J	<a href="#">Samples</a>
SN54LS49J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54LS49J	<a href="#">Samples</a>
SN7447AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN7447AN	<a href="#">Samples</a>
SN7447ANE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN7447AN	<a href="#">Samples</a>
SN74LS47D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS47	<a href="#">Samples</a>
SN74LS47DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	LS47	<a href="#">Samples</a>
SN74LS47DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM		LS47	<a href="#">Samples</a>
SN74LS47N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS47N	<a href="#">Samples</a>
SN74LS47NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74LS47N	<a href="#">Samples</a>
SN74LS47NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS47	<a href="#">Samples</a>
SNJ5447AJ	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-9856401QE A SNJ5447AJ	<a href="#">Samples</a>
SNJ5447AW	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-9856401QF A SNJ5447AW	<a href="#">Samples</a>

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SNJ54LS47FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	SNJ54LS47FK	<a href="#">Samples</a>
SNJ54LS47J	ACTIVE	CDIP	J	16	1	TBD	A42	N / A for Pkg Type	-55 to 125	7604501EA SNJ54LS47J	<a href="#">Samples</a>
SNJ54LS49J	ACTIVE	CDIP	J	14	1	TBD	A42	N / A for Pkg Type	-55 to 125	SNJ54LS49J	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF SN5447A, SN54LS47, SN7447A, SN74LS47 :**

- Catalog: [SN7447A](#), [SN74LS47](#)
- Military: [SN5447A](#), [SN54LS47](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications



**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS47DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS47DR	SOIC	D	16	2500	333.2	345.9	28.6

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - Falls within JEDEC MS-004

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE

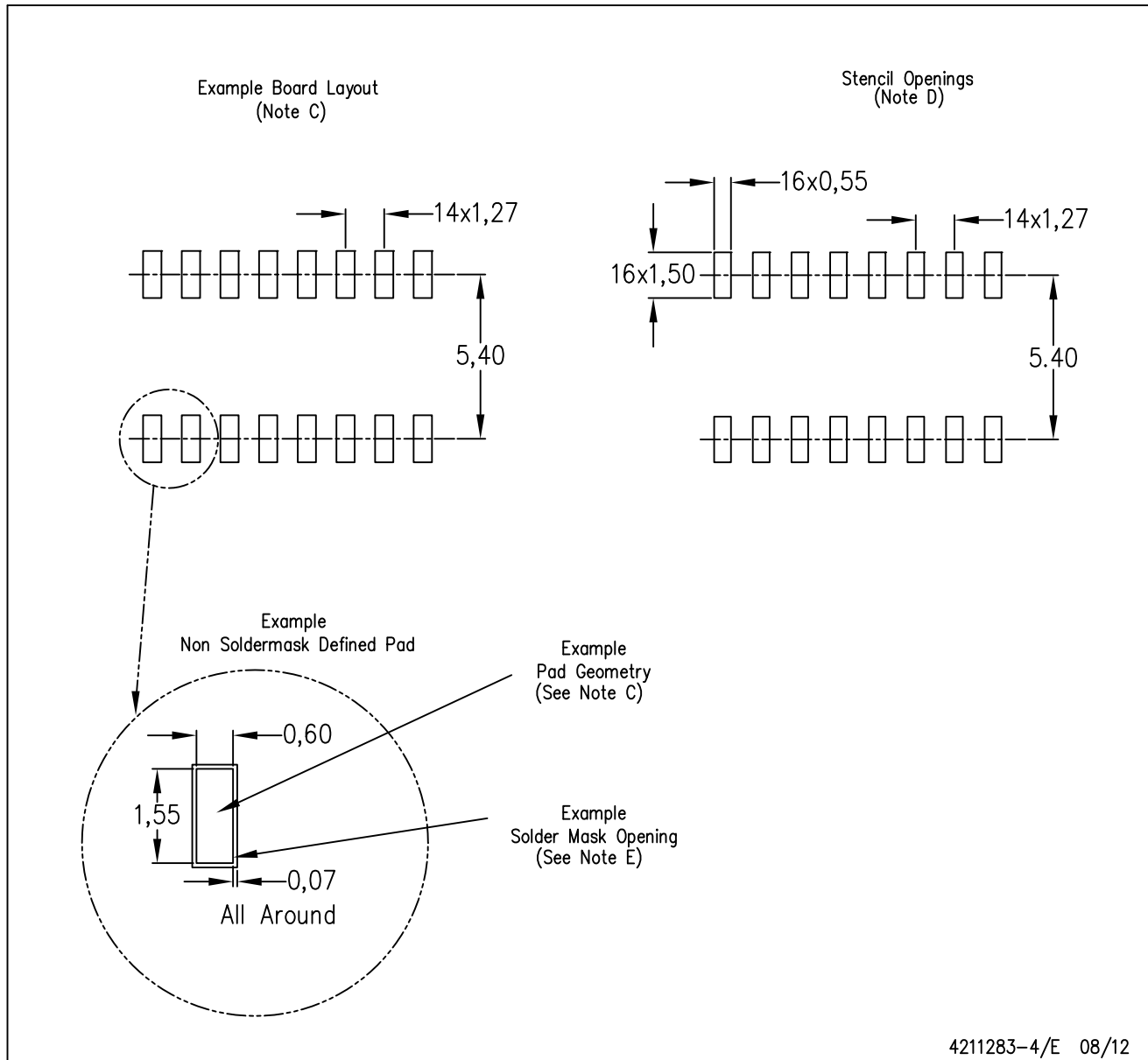


4040047-6/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AC.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



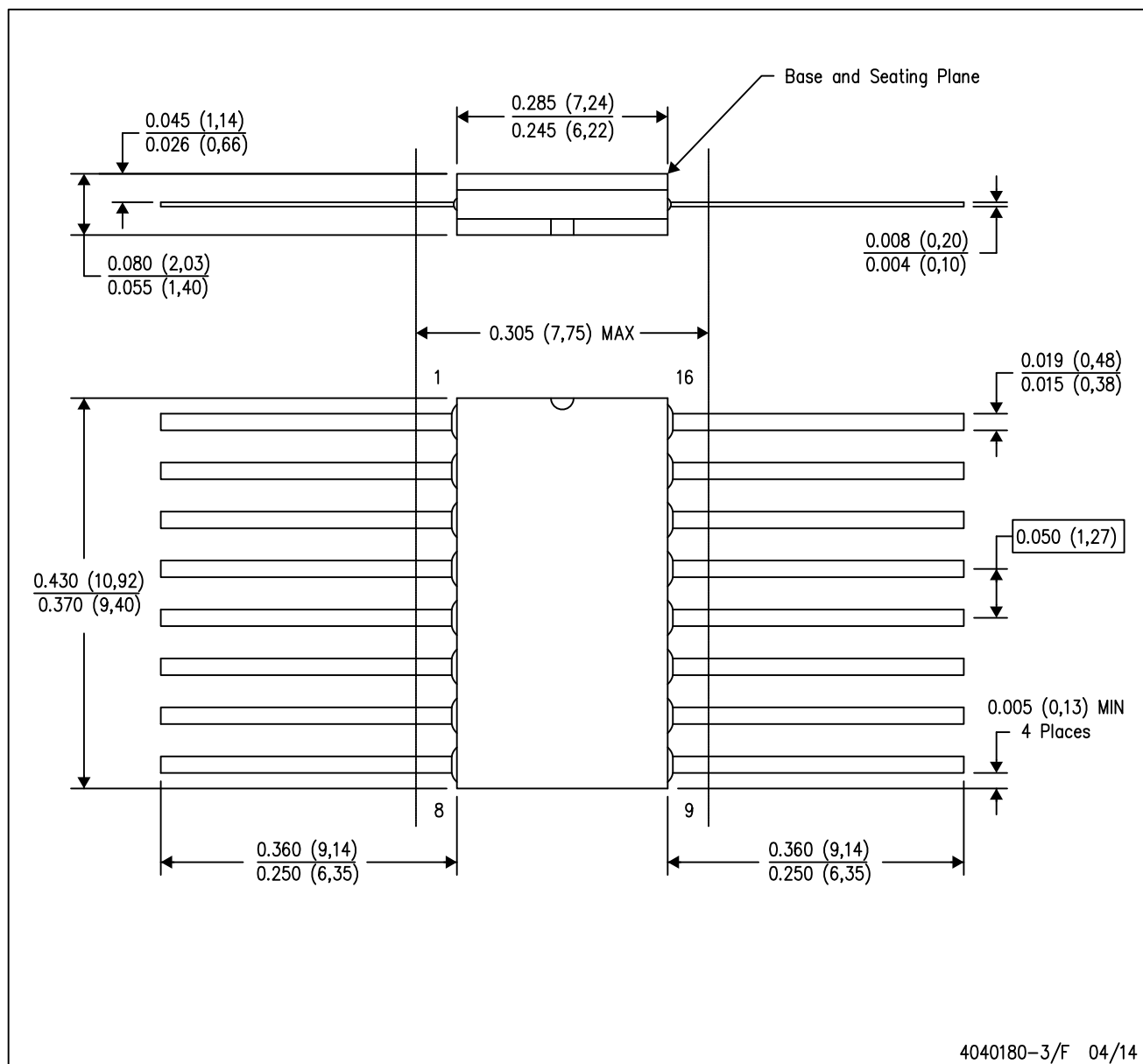
DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only.
  - Falls within MIL STD 1835 GDFP2-F16

J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.



**J 14**

## GENERIC PACKAGE VIEW

**CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4040083-5/G

**J0014A****PACKAGE OUTLINE****CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE



4214771/A 05/2017

**NOTES:**

1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package is hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
5. Falls within MIL-STD-1835 and GDIP1-T14.



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N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).  
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

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